

Breaking news from SOLEIL + Some reflections on the main topic

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5th POCPA Workshop, 24-26 May 2016, ALBA

Some words about SOLEIL

SYNCHROTRON SOLEIL: A SCIENCE PLATFORM

**Beamline operation:
Fast growing nb. of light sources**

2008: 11 BL

2009: 14 BL

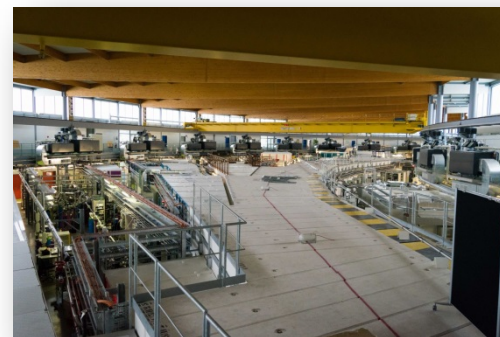
2010: 17 BL

2011: 20 BL

2013: 25 BL

2014: 27 BL

2016: 29 BL



Spectroscopies

Time resolved (fs, ms)
Very high resolution
In situ

Diffraction/Scattering

Automation, kinetics
Coherence

3D imaging

High resolution
Phase contrast
Coherence
Multi-scale
Multi-modal

Chemistry - Physical-chemistry
Properties and reactivity of model and complex systems

Biology - Health
from molecule to tissus
integrative analysis

Complex Materials
Ancient, nanomaterials
extreme conditions

Physics
Fundamental properties of matter
from ideal to complex systems
from nm to macroscopic
properties

Platforms

Medium-long term projects, support and complementary instrumentations, interfaces R&D

Ancient materials:
IPANEMA

Environmental
sciences

Biology-health

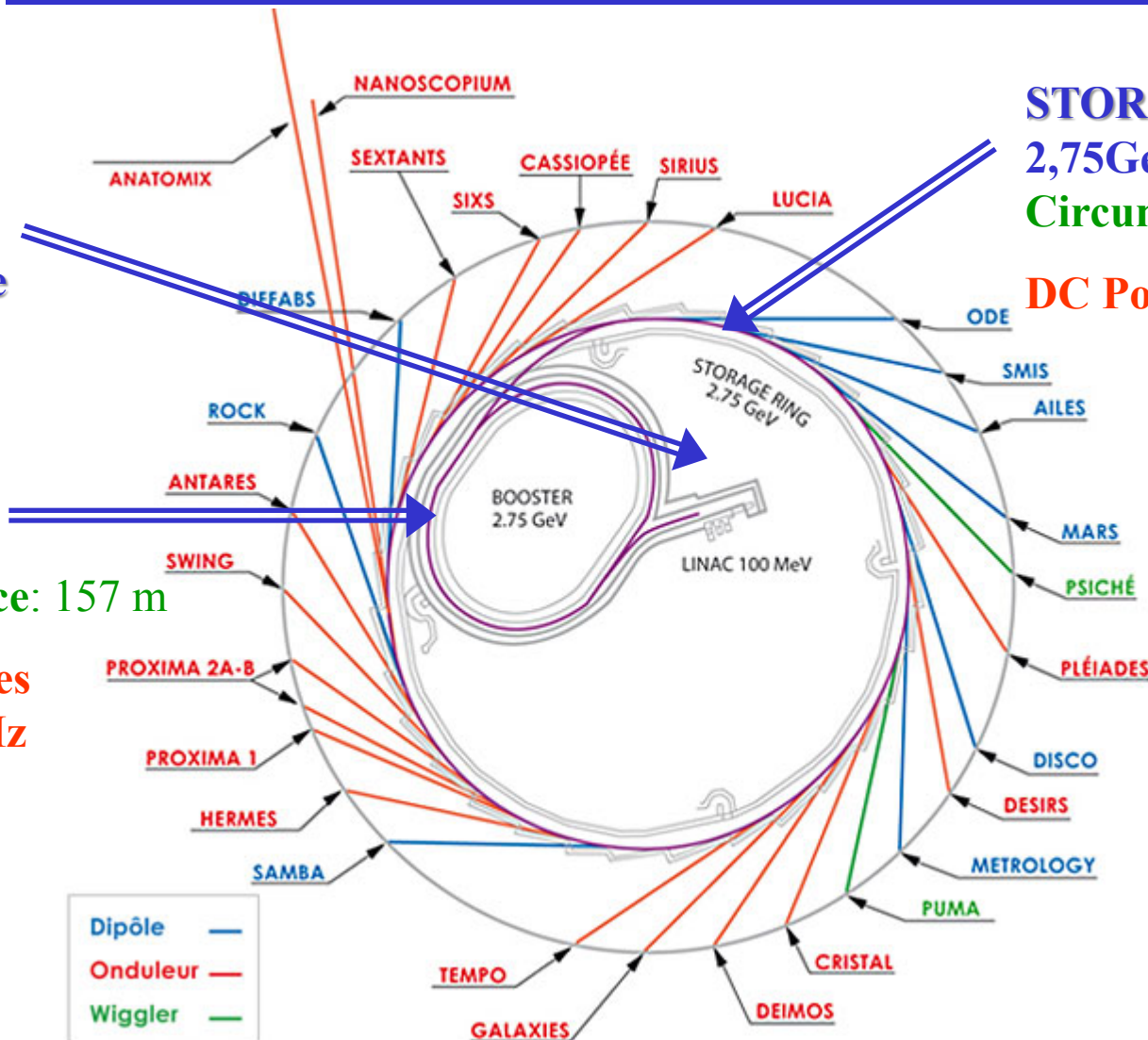
Some words about SOLEIL

LINAC
110 MeV
3 Hz rep. rate

BOOSTER
Full Energy
2,75GeV
Circumference: 157 m

Power supplies
cycling at 3 Hz

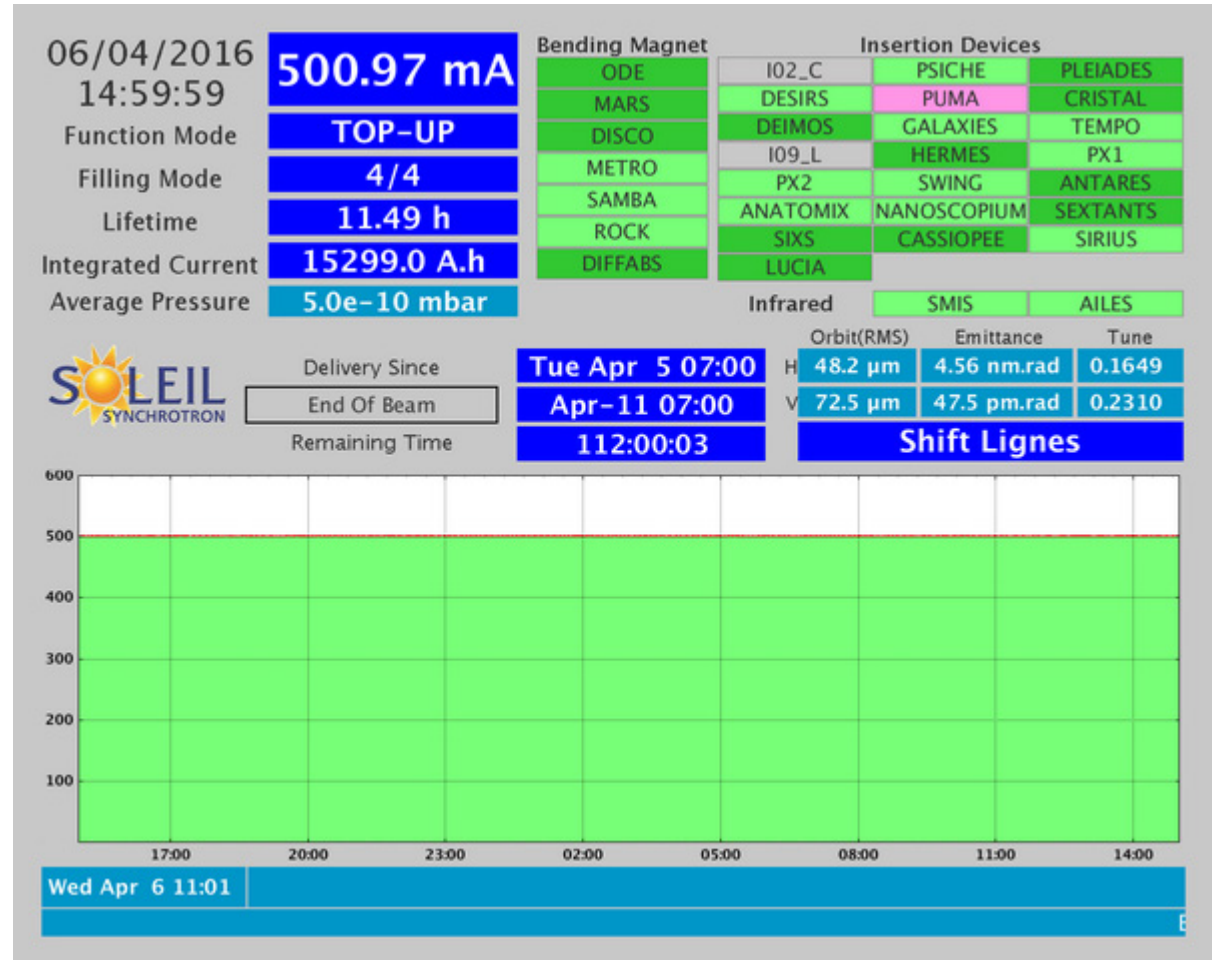
STORAGE RING
2,75GeV
Circumference: 354 m
DC Power supplies



- ☐ About 600 magnet power supplies installed
- ☐ Linac and Booster designed for Top-up operation

**Routinely operation
@ 500mA (max.
current for which the
machine has been
designed) since
December 2015**

Intensity constant within
1% (Top-Up)

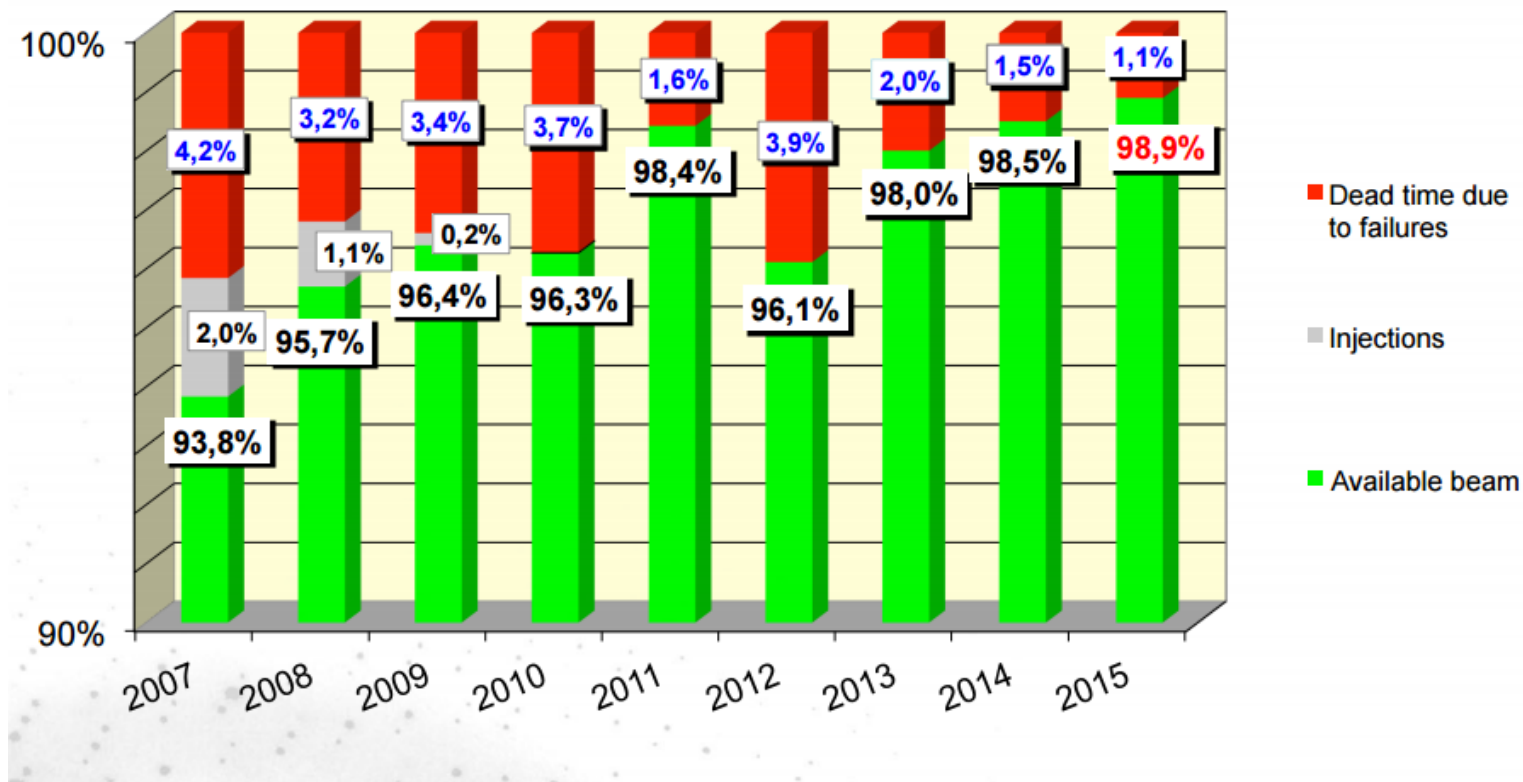


Machine status

Some statistics

- In 2015:

- ❑ User beam availability: **98,9%** (= 4904 hours of beam delivered to users)
- ❑ MTBF: 105,3 hours
- ❑ MTTR: 1h10



- In 2015:

- ❑ **Major incident in May:** 3 weeks of beam interruption due to a fire outbreak in a reactive power compensator system
- ❑ **Consequence:** Beam schedule changed → Shorter machine shutdowns (nearly no maintenance possible during the 2nd semester)
- ❑ **Good reliability & availability on the power supplies**



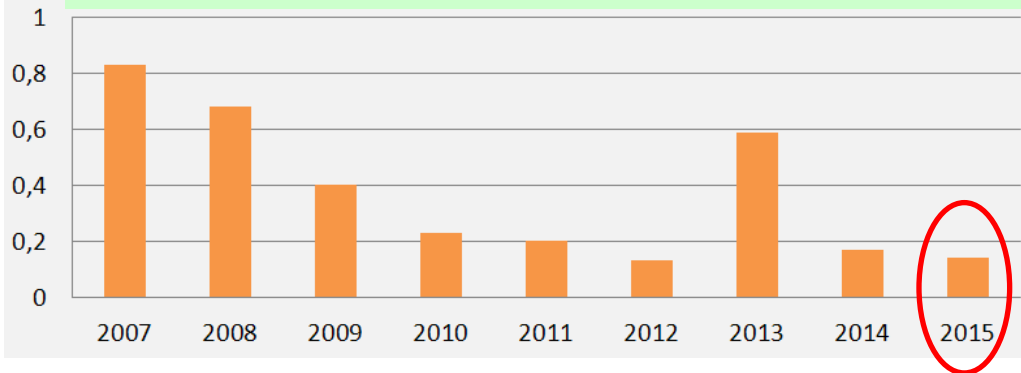
6 incidents in 2015

~ 7 hours of dead time

But 4 hours wasted following a failure of the main dipole PS:

- Normal procedure: switch the load on the spare dipole PS
- Pb: The colleague on-call didn't realize there is a neutral position on the changeover switch...
- Failure occurred at the end of his night shift → Tough!
- Written procedure should have been more detailed...

Percentage of dead time due to power supply failures over the total operational time of the synchrotron



- In 2016 until May:
 - ☐ User beam availability: 99,7%
 - ☐ Not a single incident on the power supplies



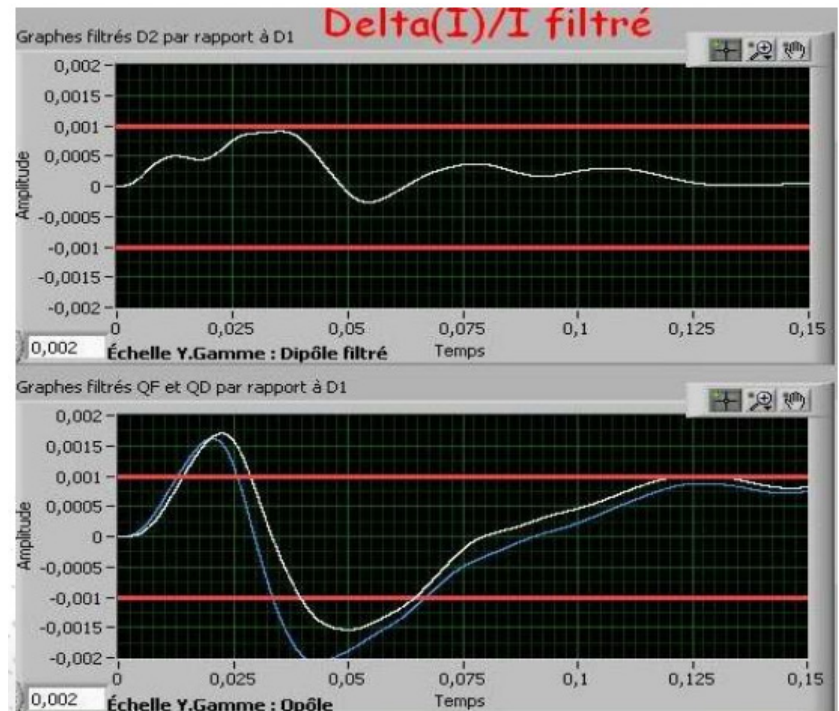
1/ Booster PS:

> May 2015: Slow drift of the beam position in the transfer line between Booster and Storage Ring \Rightarrow Need to change the current offsets / amplitudes of the Booster 3Hz PS from time to time

October: Situation gets worse (Need to tune the beam injection inside the Storage Ring every 2 or 3 days)
 \Rightarrow A dedicated machine shift is scheduled
 Result: There is a drift of the current fed by 1 of our 2 Dipole Booster PS:
Pb due to the PSI ADC/DAC card

Bad luck \rightarrow Not detected in our
 « tracking tool » used to monitor the tracking between the 3Hz PS currents:

It was out of order since March (and unfortunately no time to repair it because of the shortening of the machine shutdowns decided after the fire outbreak)



Dipole 1
versus
Dipole 2

QF, QD
versus
Dipole 1

Focus on 2 events

2/ Fire outbreak:

May 2015: 3 weeks of beam interruption due to a fire outbreak in a reactive power compensation cabinet



At SOLEIL, we have this kind of system installed on the main LV switchboards
⇒ Occurred on a 540 kVAR capacitor bank connected to the switchboard supplying the cooling tower systems

New developments

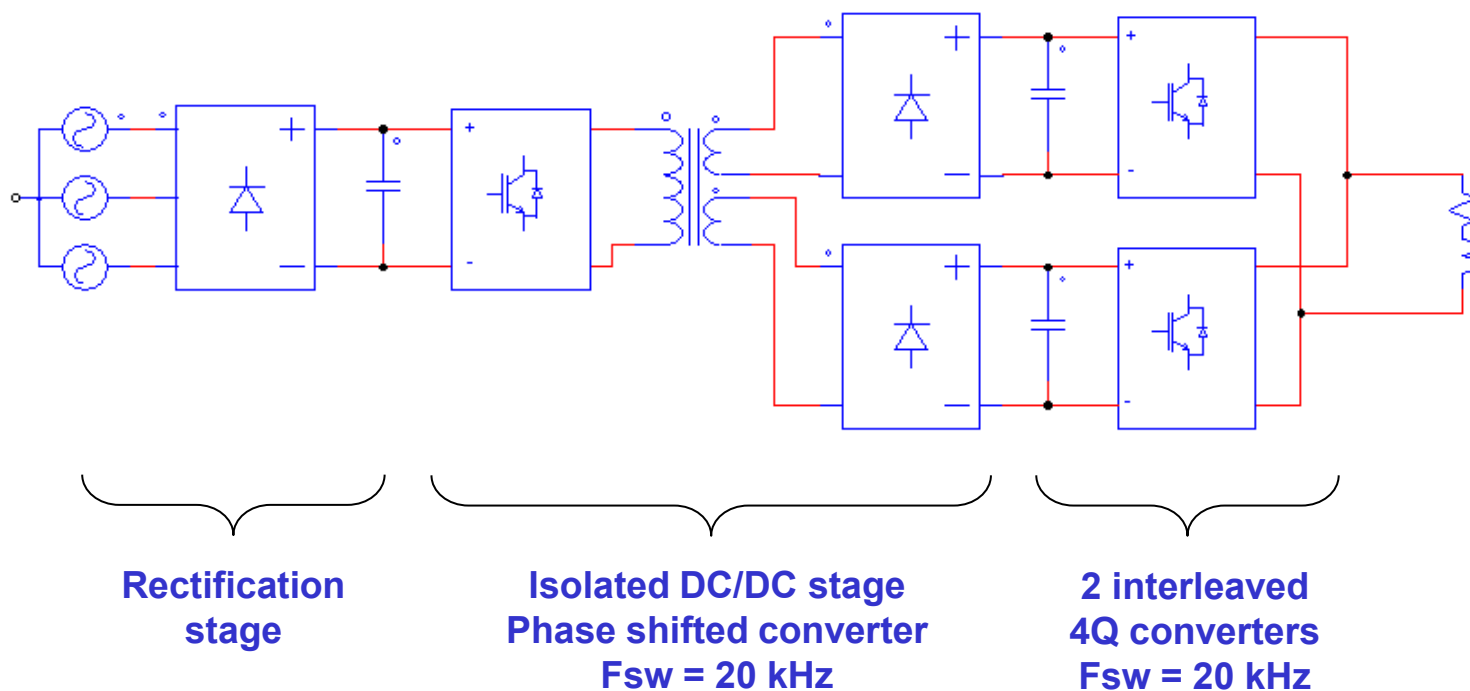
Spare power supply for electromagnetic undulators:

Can be used on different kind of loads when a failure occurs on one of the corresponding power supplies (all from DANFYSIK...)

$\pm 600\text{A} / \pm 150\text{V}$; $\pm 440\text{A} / \pm 150\text{V}$; $\pm 360\text{A} / \pm 250\text{V}$

Accuracy class: 50ppm

Topology:



Spare power supply for electromagnetic undulators:

« Bodo's Power » magazine (04/2016)



Higher Voltage Higher Current Lower Switching Loss

ROHM Semiconductor now offers a 300A full SiC power module, BSM300D12P2E001, that enables support for larger power applications such as power supplies industrial equipment.

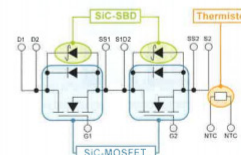
High frequency operation through reduced switching loss

- Switching loss is significantly reduced compared with similarly rated IGBT modules



Safer design supports larger currents

- Original design technology reduces inductance by half, enabling the development of 300A rated products.
- Integrated thermistor prevents excessive heat generation.



Device Configuration

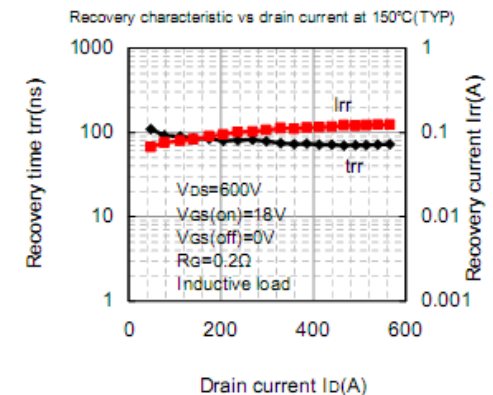
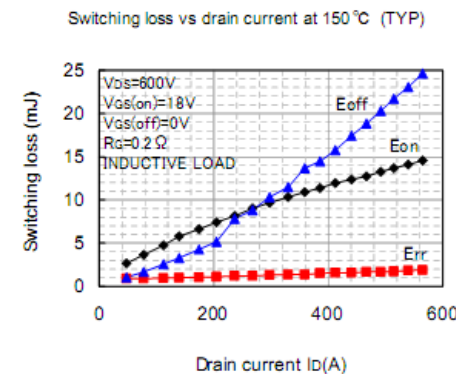
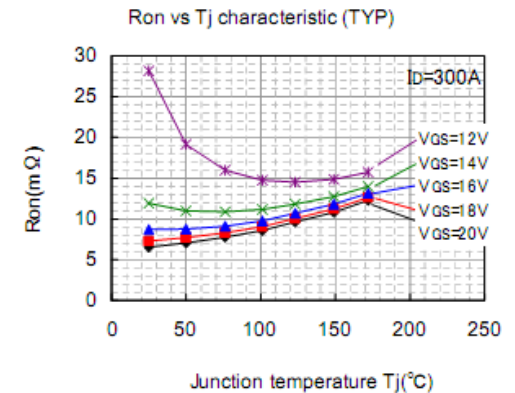
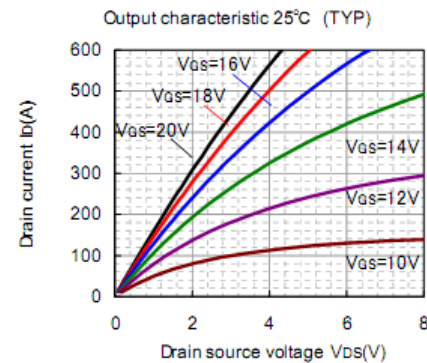
- Full H-Bridge SiC module integrates a SiC SBD and SiC MOSFET into a single package
- Equivalent package as standard IGBT modules
- Built-in thermistor
- $T_{jmax} = 175^{\circ}\text{C}$

Full SiC Power Modules Lineup

| Part No. | V_{ds} (V) | I_d (A) | T_{jmax} ($^{\circ}\text{C}$) | V_{gs} (V) | Package | Construction |
|-------------------|--------------|-----------|-----------------------------------|--------------|---------|---------------------|
| BSM080D12P2C006 * | 1200 | 80 | 175 | 2500 | C-Type | DMOS+SBD |
| BSM120D12P2C005 | 1200 | 120 | 150 | 2500 | C-Type | DMOS+SBD |
| BSM180D12P3C007 * | 1200 | 180 | 175 | 2500 | C-Type | UMOS+SBD |
| BSM300D12P2E001 | 1200 | 300 | 175 | 2500 | E-Type | DMOS+SBD+Thermistor |

* no online sample ordering possible, please contact ROHM Sales

BSM300D12P2E001



Spare power supply for electromagnetic undulators:

Comparison standard module IGBT+Diode Si vs. module MOSFET+Diode SiC

Module Si FF300R12KT4 INFINEON

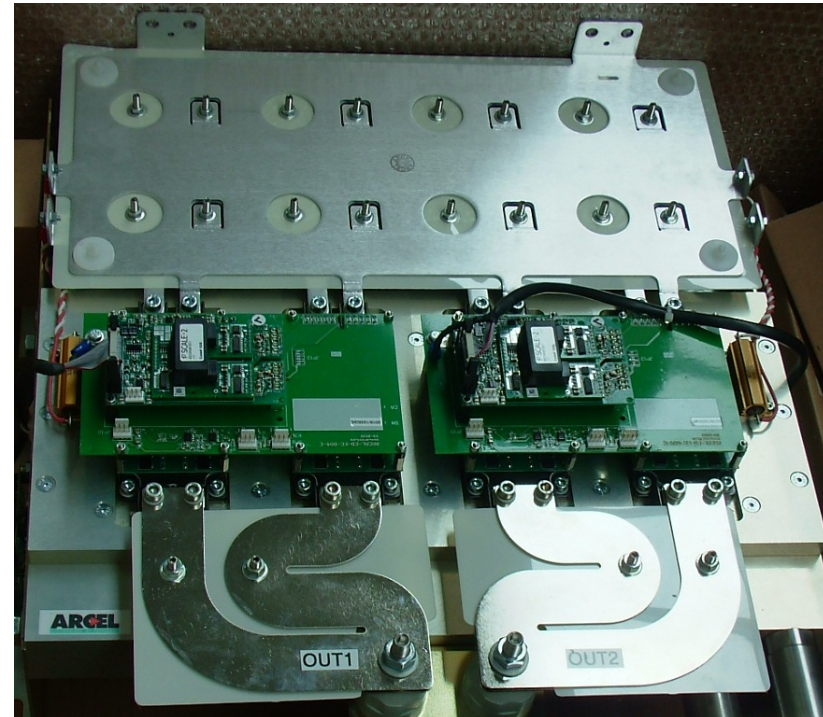
| Pcond T | Pcom T | Pcond D | Pcom D | P tot module | Tj T | Tj D |
|---------|--------|---------|--------|--------------|-------|-------|
| 165 W | 335 W | 65 W | 240 W | 805 W | 128°C | 126°C |

Module SiC BSM300D12P2E001 ROHM

| Pcond T | Pcom T | Pcond D | Pcom D | P tot module | Tj T | Tj D |
|---------|--------|---------|--------|--------------|-------|------|
| 240 W | 140 W | 80 W | 30 W | 490 W | 107°C | 89°C |

40% reduction in power
losses @ 20kHz

Use of Concept drivers with voltage level
shifter $\Rightarrow V_{GS} = +20V / -5V$



Performance specification, reviewing and testing

Some reflections on the main topic

SOLEIL construction phase:

- PS specifications not detailed enough, especially in terms of EMC (only a list of standards to comply with...)
- Reviewing: Sizing of main power components (semiconductors, capacitors, etc...) not checked
- Testing: Mainly measurements of output characteristics (current precision + voltage ripple in DM), no thermal / EMC measurements...

⇒ **Serious troubleshooting during first years of operation**



A positive point nonetheless:

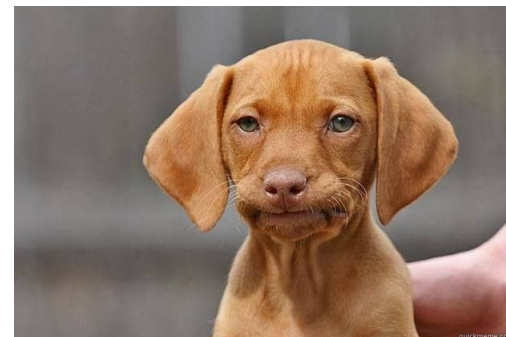
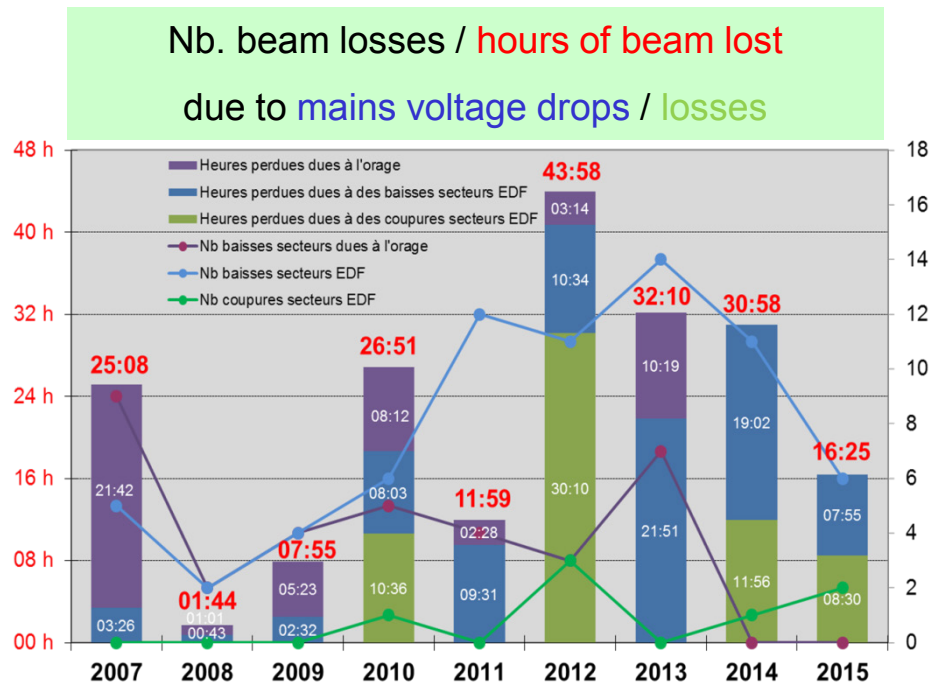
Documentation complete (Schematics, BOM, manuals, Gerber files, firmware sources except those from DANFYSIK...)

Some reflections on the main topic

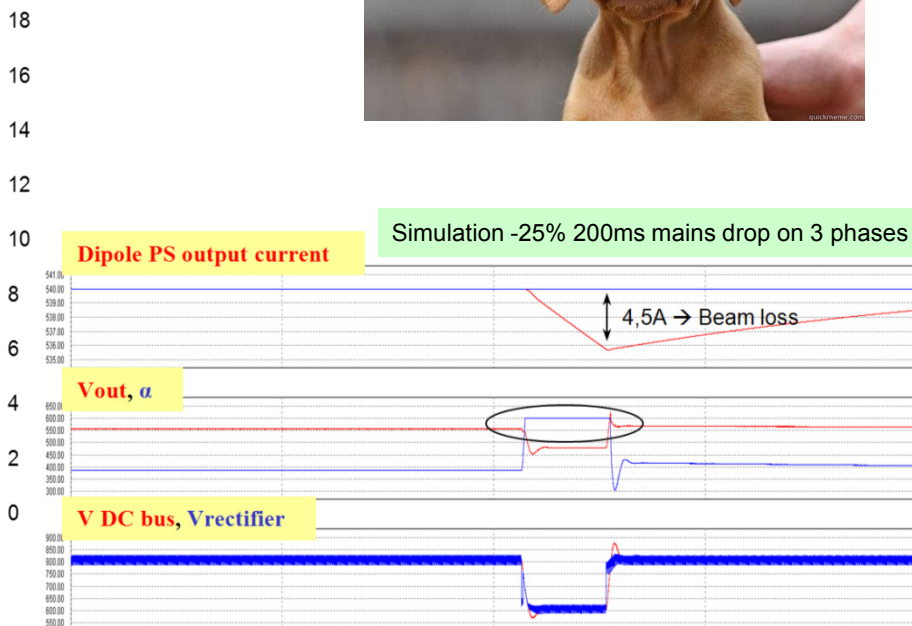
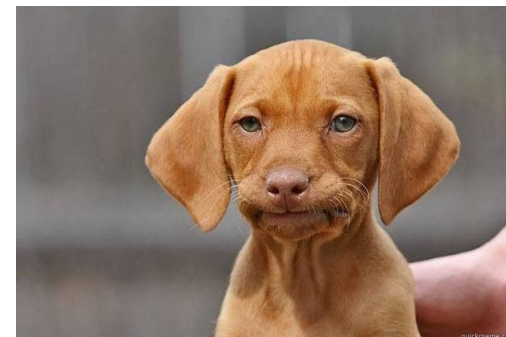
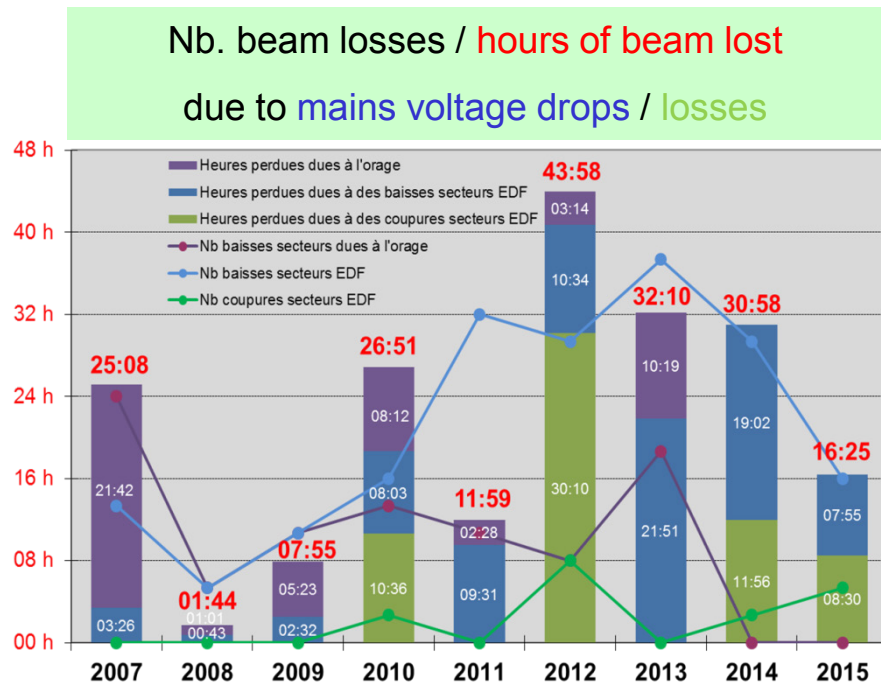
Non exhaustive list of items that should be detailed in a technical specification:

- Power converter ratings
- Load characteristics, magnet cycles, di/dt limits
- Static performance (current precision, ripples)
- Dynamic performance (reference tracking, overshoots, AC line disturbance rejection)
- Synchronisation between PS if required
- Control system
- Internal / external interlocks
- Magnet earthing
- Environment (Electricity, cooling)
- Efficiency, power factor, THD
- Layout, weight / volume
- Contract execution, schedule, progress report, acceptance tests
- Documentation
- Spare parts
- EMC (immunity / emissions)
- Acoustic noise
- Design rules (semiconductors, capacitors, fans...)
- Reparability

- AC line disturbance rejection



- AC line disturbance rejection

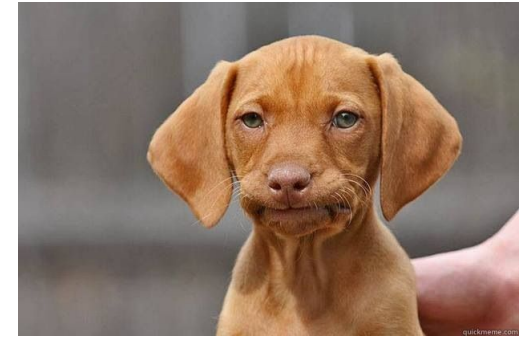
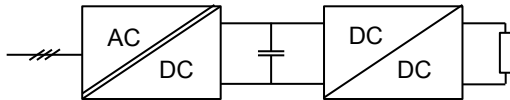


Most events: Voltage dips < 25% on 1 to 3 phases with a duration < 150ms

| Storage Ring power supplies | Dipole PS 610V/580A | Spare Dipole PS 610V/580A | Spole PS 75V/350A | Spole PS 140V/350A | Qpole PS 14V/250A | Qpole PS 22V/250A |
|---|------------------------|------------------------------|----------------------|-----------------------|----------------------|----------------------|
| % of DC link voltage drop causing saturation of regulation (for usual current setpoints) | 12% | 25% | 55% | 30% | 45% | 40% |

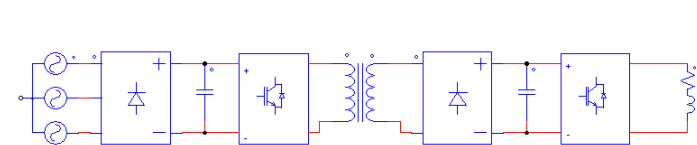
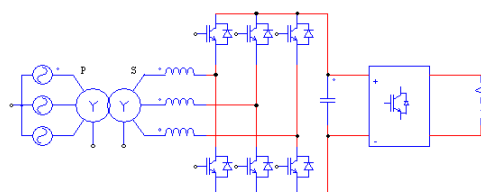
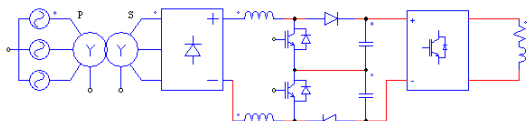
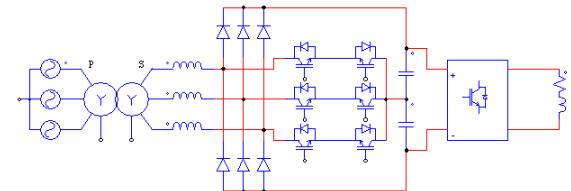
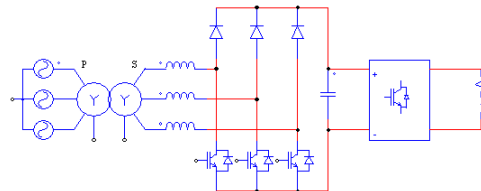
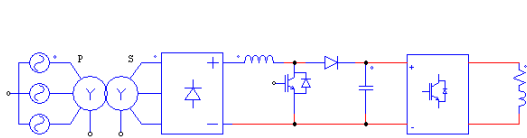
- AC line disturbance rejection

Typical converter topology



Possible solutions:

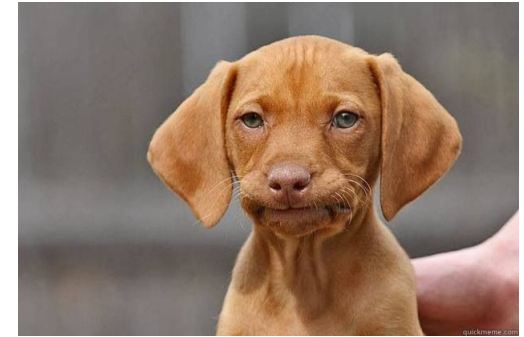
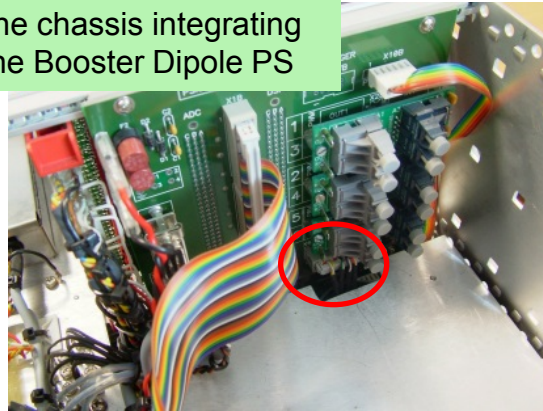
- Diode rectification stage delivering high enough DC link voltage to avoid saturation of output stage converter during mains voltage sags
 - Controlled AC/DC input stage to regulate DC link voltage at the desired value
- Galvanic isolation: Possibility to introduce a high frequency transformer (weight/volume ↘)
- PFC circuits can be implemented



Some reflections on the main topic

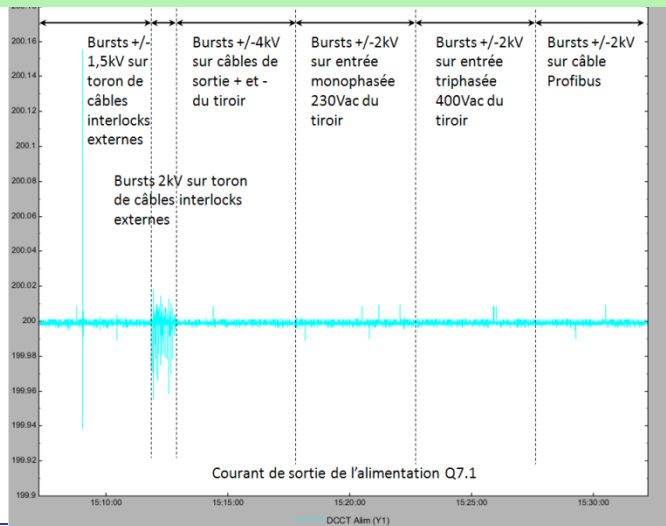
- AC line disturbance rejection
- EMC (immunity / emissions)

2007 : Serious EMC pb with the chassis integrating the PSI regulation cards on the Booster Dipole PS



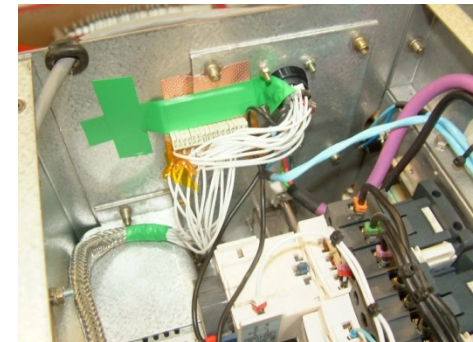
DSP crash in master/slave configuration:
Use of unshielded flat ribbon cable for the serial link between PSI master & slave cards (= transmission line)
The good solution: Common backplane card for master and slave cards with controlled trace impedance

Poor EMC on the SR Quadrupole PS

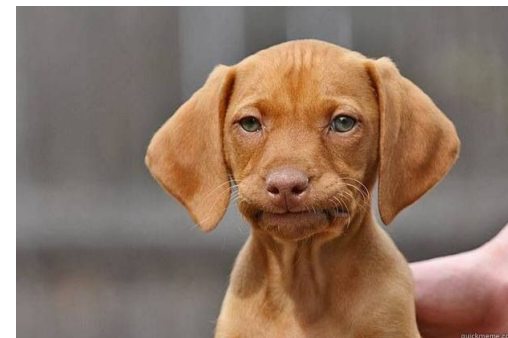


Fast transient burst immunity test

⇒ CM filtering of external AON I/O



- AC line disturbance rejection
- EMC (immunity / emissions)
- Acoustic noise



The switching frequencies of most of our converters are > 20 kHz

Big converters (Storage Ring Dipole PS, Booster Dipole PS...): Around 10 kHz (efficiency)

⇒ Acoustic noise!

- Design rules (semiconductors, capacitors, fans...)

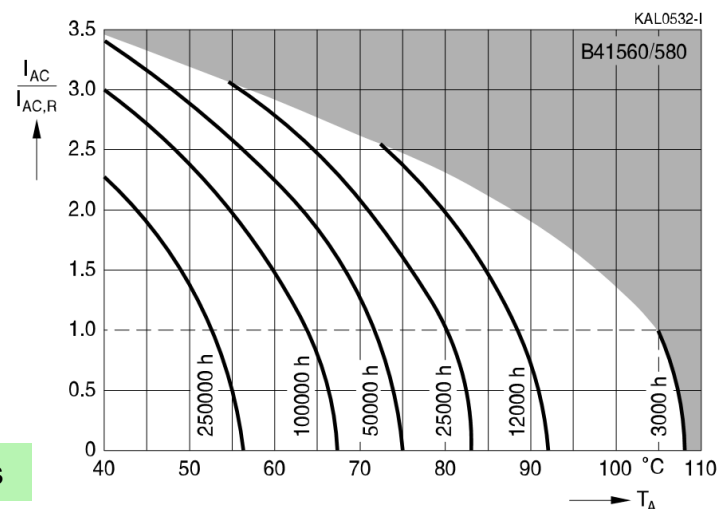
Ex: Capacitor lifetime $> 100\,000$ hours in all operating conditions



SR Dipole PS: Redesigned DC link capacitor banks ⇒ 120 000 hours

Useful life¹⁾

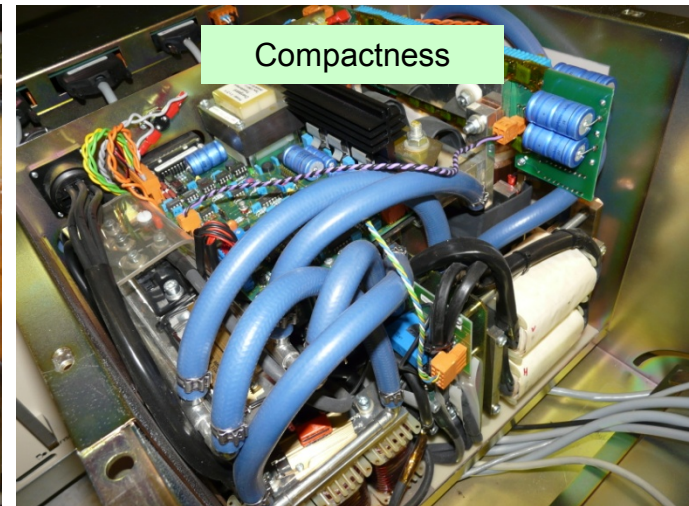
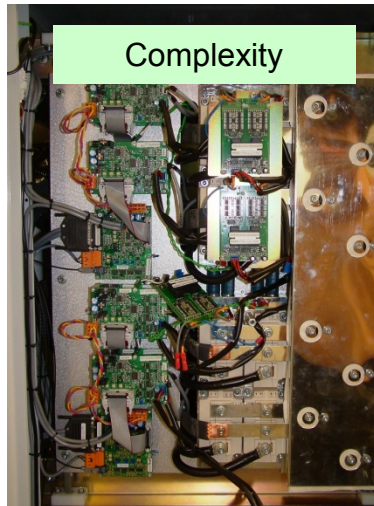
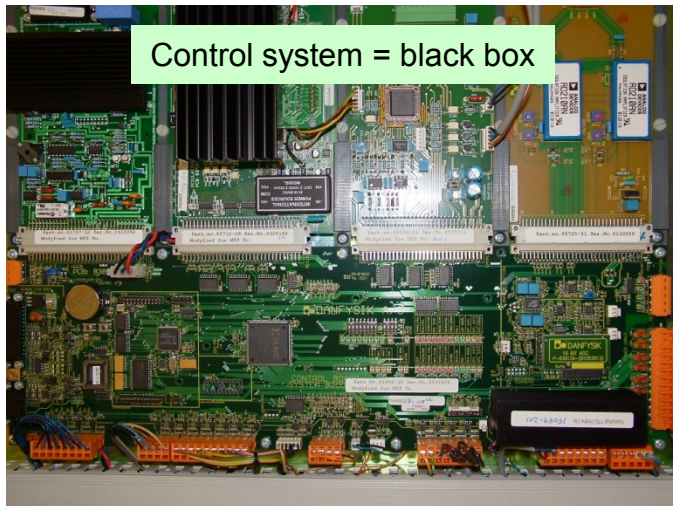
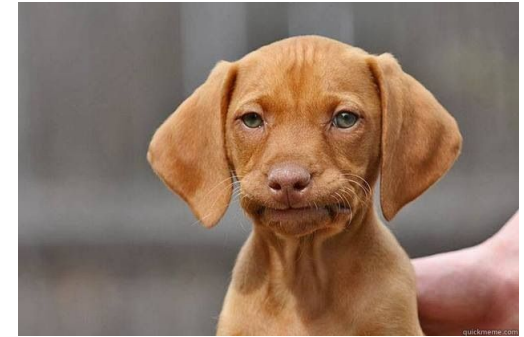
depending on ambient temperature T_A under ripple current operating conditions



Some reflections on the main topic

- AC line disturbance rejection
- EMC (immunity / emissions)
- Acoustic noise
- Design rules (semiconductors, capacitors, fans...)
- Reparability

Unfortunate choice: DANFYSIK power supplies

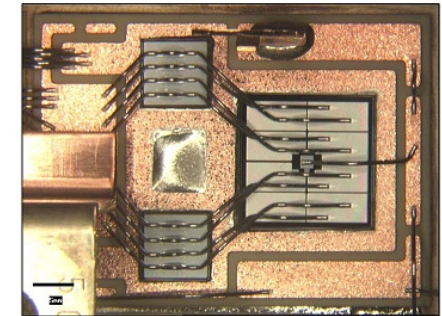
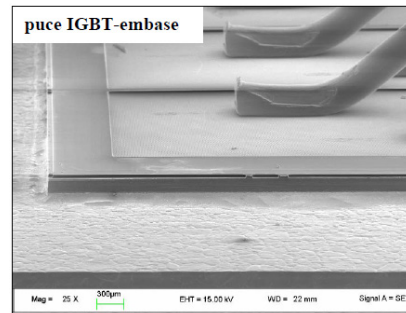
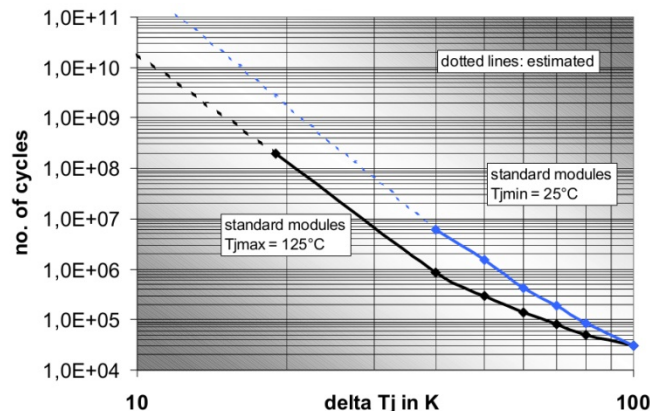
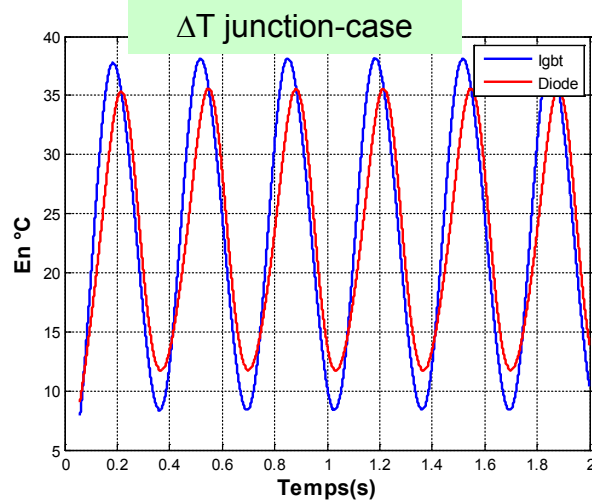


Reviewing: Draw upon knowledge and experience of PS experts from other accelerator facilities

Example: Short lifetime of the IGBT modules in our main 3Hz Booster power supplies

Cause: Harsh power & thermal cycling conditions

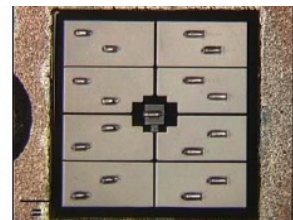
Bonding wire pull test on 3 IGBT modules



Module 1: New

REF

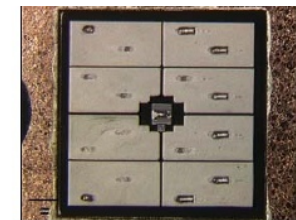
(Wedge arraché : 0/64)



Module 2:

5 Millions cycles

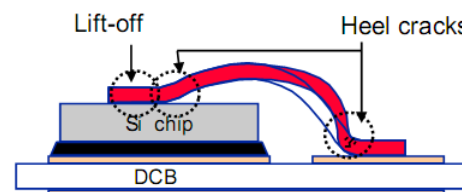
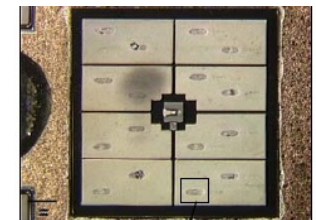
(Wedges arrachés : 43/64)



Module 3:

25 Millions cycles

(Wedges arrachés : 60/64)



⇒ Many failures between 2006 and 2014

Reviewing: Draw upon knowledge and experience of PS experts from other accelerator facilities

Example: Short lifetime of the IGBT modules in our main 3Hz Booster power supplies

Cause: Harsh power & thermal cycling conditions

New design in 2014 (~ 120 k€ project, spares included)



< IGBT MODULES >

CM2500DY-24S

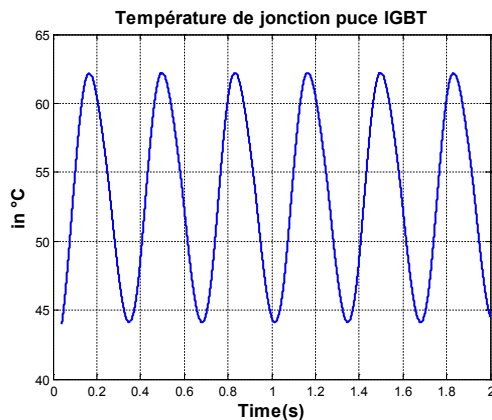
HIGH POWER SWITCHING USE
INSULATED TYPE



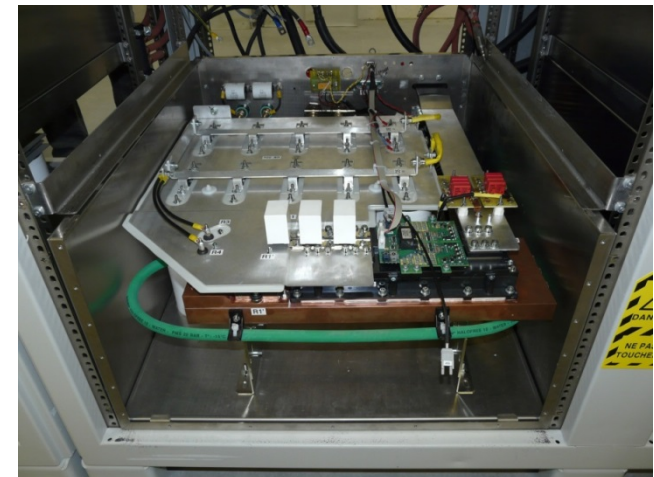
Dual switch (Half-Bridge)

Collector current I_C 2 5 0 0 A
Collector-emitter voltage V_{CES} 1 2 0 0 V
Maximum junction temperature T_{jmax} 1 7 5 °C

- Flat base Type
- Aluminum base plate
- RoHS Directive compliance
- Recognized under UL1557, File E323585



⇒ IGBT cycling capability
> 200 Millions (~ 20 years)



Some reflections on the main topic

Testing: You need tools (seems obvious and it is)...



Questions



**Thank you for your attention.
Questions ?**